## PCIE Module for PCIe Bus Expansion

# **PCI113**





#### **KEY FEATURES**

- PCle x8 lanes Gen2
- Upstream/Downstream orientation
- Dual Fiber or copper option utilizing QSFP+ connectors (mix of Fiber/Copper across the two ports is allowed)
- Fully IPMI 2.0 compliant
- RoHS compliant
- OS support for:
  - Linux
  - Windows
  - Solaris
  - VxWorks

PCI113 is VadaTech second generation PCIe expansion module. The PCI113 is a high-speed 20Gbps bridge from the host PCIe bus to VadaTech's carrier and Rear Transition Module (RTM) products such as the ATC104/114/118/117/119, ART114,  $\mu$ TCA chassis, etc.. The different carriers host different I/O modules such as PMC/PrPMC, AMC, PCI-X and PCIe edge modules. This concept allows any of the available I/O modules in these standard form factors to be integrated quickly and easily into an AdvancedTCA or  $\mu$ TCA subsystem.

The PCI113 allows expansion among multiple  $\mu$ TCA chassis or expansion into other chassis that are not ATCA or  $\mu$ TCA based.

The PCI113 is a single-width PCIE based on the PCISIG specification. The PCI113 provides a PCIe x4 link in fiber/copper via front panel QSFP. The dual front I/O allows expansion into two separate system independently. The upstream port must not have spread spectrum PCIe clock enabled.

VadaTech can modify this product to meet special customer requirements without NRE (minimum order placement is required).

## PCIE Module for PCle Bus Expansion

### **SPECIFICATIONS**

Architecture		
		Width: 4.2 in. (107 mm)
Physical	Dimensions	Depth: 7.8 in. (181.5 mm)
Туре	PCI Expansion Module	PCI module for I/O bus expansion
Standards		
PCle	Lanes	х8
Configuration		
Power	Copper QSFP cable	4W maximum
	Fiber QSFP cable	7W maximum
Environmental	Temperature	Operating Temperature: 0° to 65° C
		Storage Temperature: -40° to +90° C
	Vibration	1G, 5-500Hz each axis
	Shock	30Gs each axis
	Relative Humidity	5 to 95 percent, non-condensing
Front Panel	Interface Connectors	Dual QSFP+
		RS-232
	LEDs	Link
	Mechanical	Hot Swap Ejector Handle
Software Support	Operating Systems	Linux, Windows, Solaris and VxWorks
Other		
MTBF	MIL Spec 217-F >TBD	
Certifications	Designed to meet FCC, CE and UL certifications where applicable	
Standards	VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards	
Compliance	RoHS and NEBS	
Warranty	Two (2) years	
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	Manufacturers Group. All rights reserved. Specification subject to change without notice.	
Notes	The Half-Height front panel is a patent-pending design. Contact your Sales representative for more information.	

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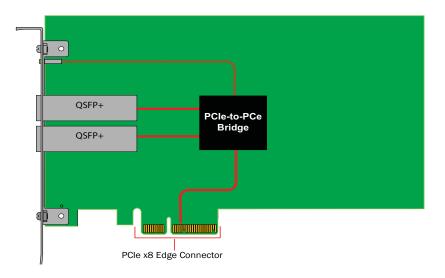
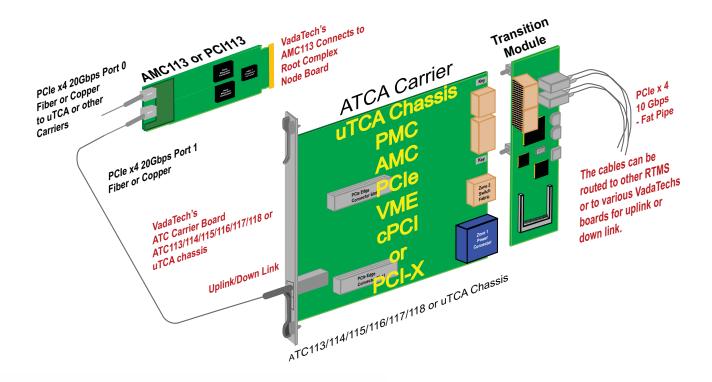


FIGURE 1. PCI113 Functional Block Diagram

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FIGURE 2. An Example of using the PCI113 with the PCIe up/down stream ports



### **ORDERING OPTIONS**



- 1 = Humiseal 1A33 Polyurethane

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